

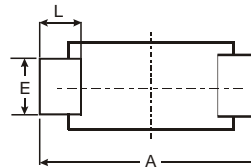
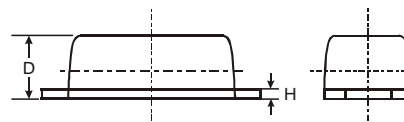
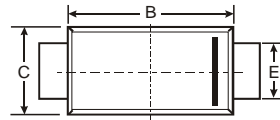
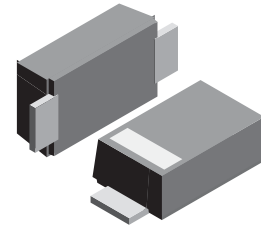
VOLTAGE RANGE: 50 - 600V
CURRENT: 1.0A

Features

- Glass passivated device
- Ideal for surface mounted applications
- Low reverse leakage
- Metallurgically bonded construction
- High temperature soldering guaranteed:
250°C/10 seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

Mechanical Data

- Case: SOD-123FL
plastic body over passivated junction
- Terminals : Plated axial leads,
solderable per MIL-STD-750, Method 2026
- Polarity : Color band denotes cathode end
- Mounting Position : Any
- Weight: 0.0007 ounce, 0.02 grams



SOD-123FL			
Dim	Min	Max	Typ
A	3.58	3.72	3.65
B	2.72	2.78	2.75
C	1.77	1.83	1.80
D	1.02	1.08	1.05
E	0.097	1.03	1.00
H	0.13	0.17	0.15
L	0.53	0.57	0.55
All Dimensions in mm			

Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	ES1AFL	ES1BFL	ES1CFL	ES1DFL	ES1EFL	ES1GFL	ES1JFL	Unit
	Marking	1AF	1BF	1CF	1DF	1EF	1GF	1JF	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	600	VOLTS
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	VOLTS
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	VOLTS
Maximum average forward rectified current	I(AV)	1.0							Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	25.0							Amps
Maximum instantaneous forward voltage at 1.0A	V _F	0.95			1.25		1.7		Volts
Maximum DC reverse current <small>T_A = 25°C</small> at rated DC blocking voltage <small>T_A = 100°C</small>	I _R	5.0 100.0							μA
Maximum reverse recovery time (NOTE 1)	t _{rr}	35							ns
Typical junction capacitance (NOTE 2)	C _J	10							pF
Typical thermal resistance (NOTE 3)	R _{θJA}	85							K/W
Operating junction and storage temperature range	T _{JTSTG}	-55 to +150							°C

Note: 1. Measured with I_F=0.5A, I_R=1A, I_{rr}=0.25A.
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
3. PCB mounted on 0.2*0.2" (5.0*5.0mm) copper pad area.

RATINGS AND CHARACTERISTIC CURVES ES1AFLTHRU ES1JFL

FIG. 1- FORWARD CURRENT DERATING CURVE

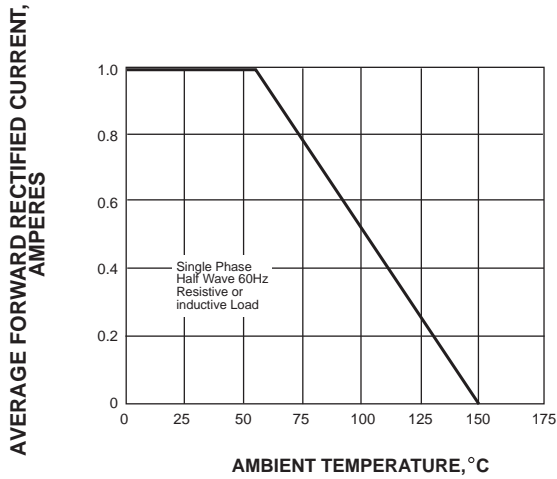


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

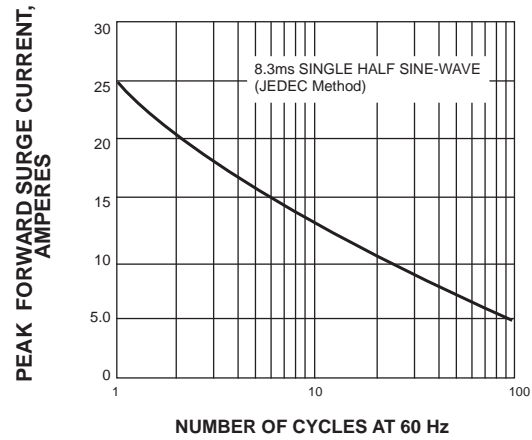


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

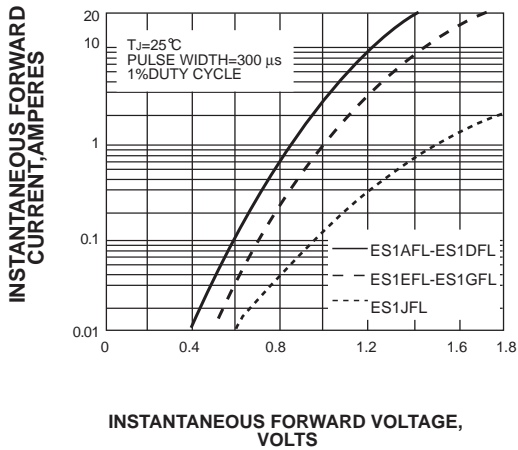


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

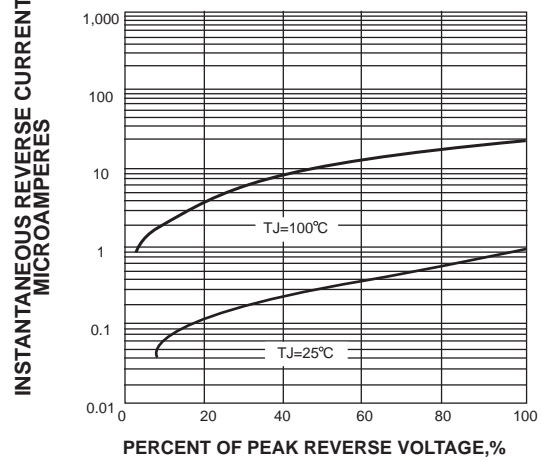


FIG. 5-TYPICAL JUNCTION CAPACITANCE

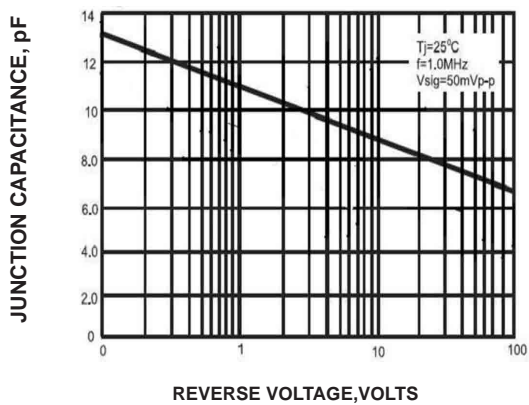


FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE

